

Reltek BONDiT™ B-536TH Adhesive System

Category : Polymer , Adhesive

Material Notes:

Key PropertiesVery high strength bonding of dissimilar materials. High moisture and solvent resistance. Fast ambient cure with good pot life. Ease of use. **Applications**Outstanding adhesive for very high strength potting and assembly applications. Bonds most plastics, metals, glass and ceramics. Good for electronics applications. High moisture resistance. Full cure 60 minutes at ambient or 10 minutes at 170° F or higher temperatures for faster cure down to 15 sec. Information provided by Reltek LLC

Order this product through the following link:

http://www.lookpolymers.com/polymer_Reltek-BONDiT-B-536TH-Adhesive-System.php

Physical Properties	Metric	English	Comments
Specific Gravity	1.05 g/cc	1.05 g/cc	A
	1.42 g/cc	1.42 g/cc	B
Viscosity	2500 cP	2500 cP	

Mechanical Properties	Metric	English	Comments
Tensile Strength at Break	51.15 MPa	7418 psi	
Tensile Strength, Yield	53.04 MPa	7693 psi	
Elongation at Break	9.2 %	9.2 %	
Elongation at Yield	8.6 %	8.6 %	

Descriptive Properties	Value	Comments
Color	Clear with slight amber	
Peak Stress (psi)	7693	

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